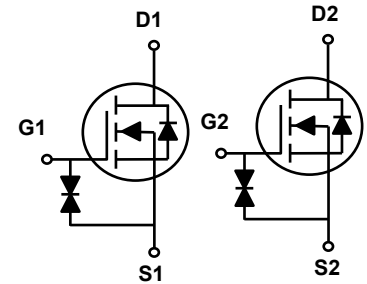
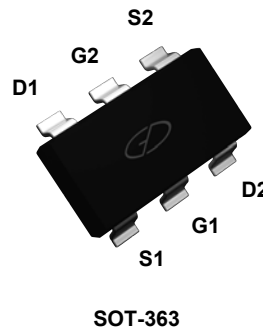


### Main Product Characteristics

$V_{DS}$	30V
$R_{DS(ON)}$	450m $\Omega$
$I_D$	800mA



Schematic Diagram

### Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switch mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



### Description

The GSFK0300B utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

### Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Drain Current-Continuous ( $T_C=25^\circ\text{C}$ )	$I_D$	800	mA
Drain Current-Continuous ( $T_C=100^\circ\text{C}$ )		640	mA
Drain Current-Pulsed <sup>1</sup>	$I_{DM}^1$	3.2	A
Power Dissipation ( $T_C=25^\circ\text{C}$ )	$P_D$	275	mW
Power Dissipation-Derate Above $25^\circ\text{C}$		2.2	mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	450	$^\circ\text{C}/\text{W}$
Storage Temperature Range	$T_{STG}$	-55 To +150	$^\circ\text{C}$
Operating Junction Temperature Range	$T_J$	-55 To +150	$^\circ\text{C}$

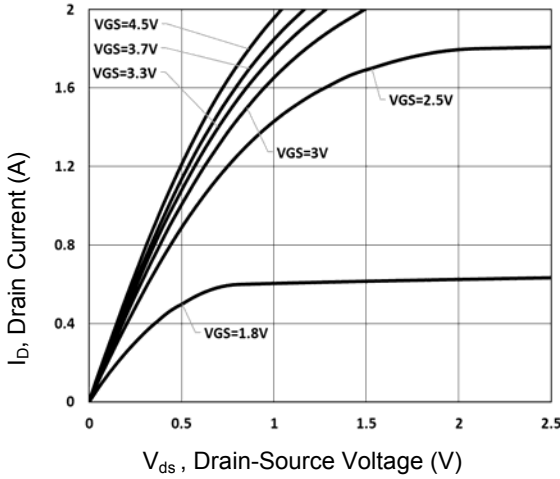
### Electrical Characteristics ( $T_J=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
$BV_{DSS}$ Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to $25^{\circ}\text{C}$ , $I_D=1\text{mA}$	-	-0.01	-	$\text{V}/^{\circ}\text{C}$
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=30V, V_{GS}=0V,$ $T_J=25^{\circ}\text{C}$	-	-	1	$\mu A$
		$V_{DS}=24V, V_{GS}=0V,$ $T_J=125^{\circ}\text{C}$	-	-	10	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 12V, V_{DS}=0V$	-	-	$\pm 20$	$\mu A$
<b>On Characteristics</b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS},$	0.65	0.8	1.5	V
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}$	$I_D=250\mu A$	-	-1.74	-	$\text{mV}/^{\circ}\text{C}$
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=4.5V, I_D=0.3A$	-	370	450	m $\Omega$
		$V_{GS}=2.5V, I_D=0.2A$	-	510	650	
Forward Transconductance	$g_{FS}$	$V_{DS}=4V, I_D=0.3A$	-	0.8	-	S
<b>Dynamic and Switching Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=15V, V_{GS}=0V,$ $F=1.0\text{MHz}$	-	72.9	146	PF
Output Capacitance	$C_{oss}$		-	18.3	36.6	
Reverse Transfer Capacitance	$C_{rss}$		-	7.4	14.8	
Turn-On Delay Time <sup>2,3</sup>	$t_{d(on)}$	$V_{DD}=15V, I_D=0.3A$ $V_{GS}=4.5V, R_G=10\Omega$	-	5.5	11	nS
Rise Time <sup>2,3</sup>	$t_r$		-	4	8	
Turn-Off Delay Time <sup>2,3</sup>	$t_{d(off)}$		-	14.5	29	
Fall Time <sup>2,3</sup>	$t_f$		-	6.5	13	
Total Gate Charge <sup>2,3</sup>	$Q_g$	$V_{DS}=15V, I_D=0.3A,$ $V_{GS}=4.5V$	-	2.6	5.2	nC
Gate-Source Charge <sup>2,3</sup>	$Q_{gs}$		-	0.9	1.8	
Gate-Drain Charge <sup>2,3</sup>	$Q_{gd}$		-	0.6	1.2	
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=0.3A,$ $T_J=25^{\circ}\text{C}$	-	-	1	V
Continuous Source Current	$I_S$	$V_G=V_D=0V,$ Force Current	-	-	0.8	A
Pulsed Source Current	$I_{SM}$		-	-	1.6	A

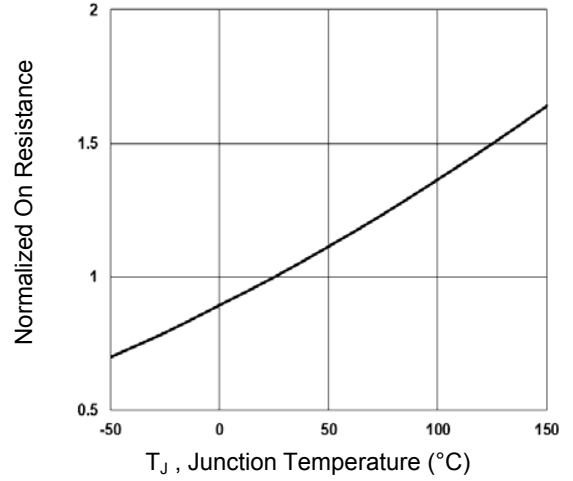
Note :

1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
2. Pulse test: pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
3. Essentially independent of operating temperature.

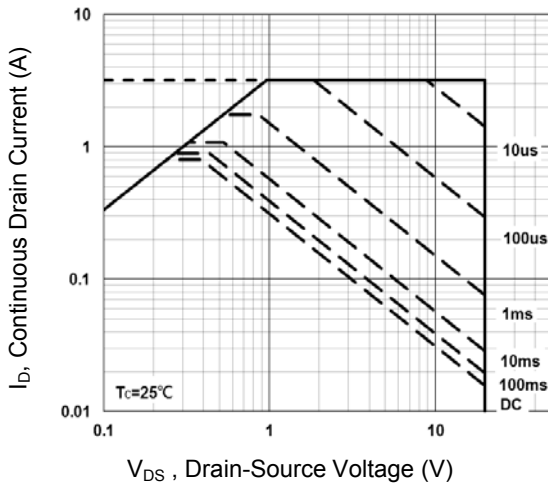
**Typical Electrical and Thermal Characteristic Curves**



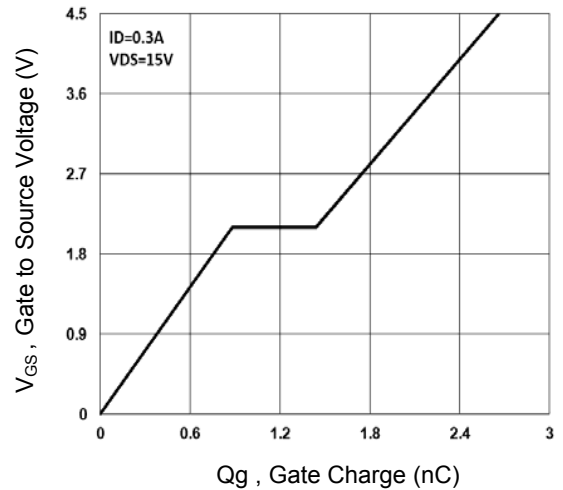
**Figure 1. Typical Output Characteristics**



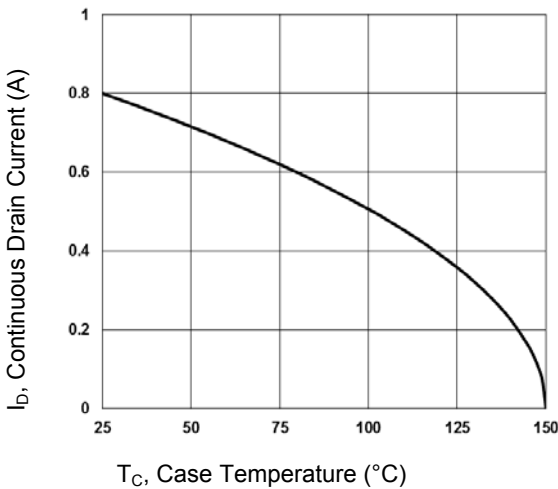
**Figure 2. Normalized  $R_{DS(ON)}$  vs.  $T_J$**



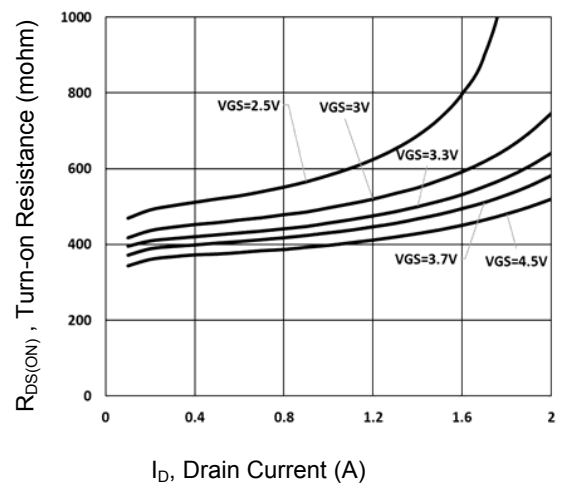
**Figure 3. Maximum Safe Operation Area**



**Figure 4. Gate Charge Waveform**

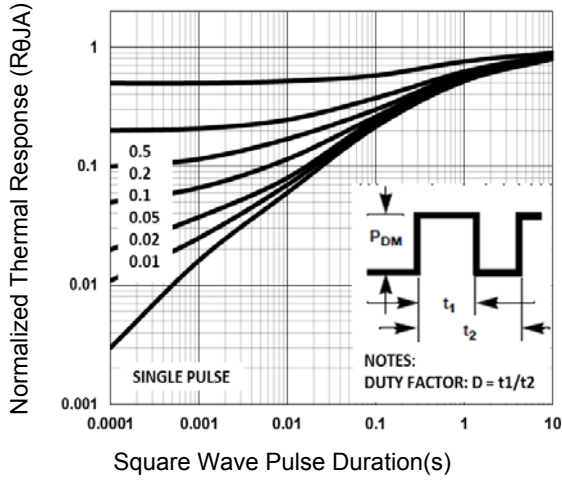


**Figure 5. Continuous Drain Current vs.  $T_C$**

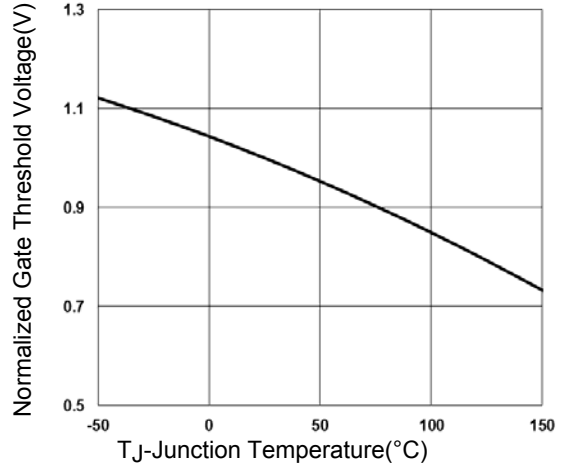


**Figure 6. Turn-On Resistance vs.  $I_D$**

**Typical Electrical and Thermal Characteristic Curves**

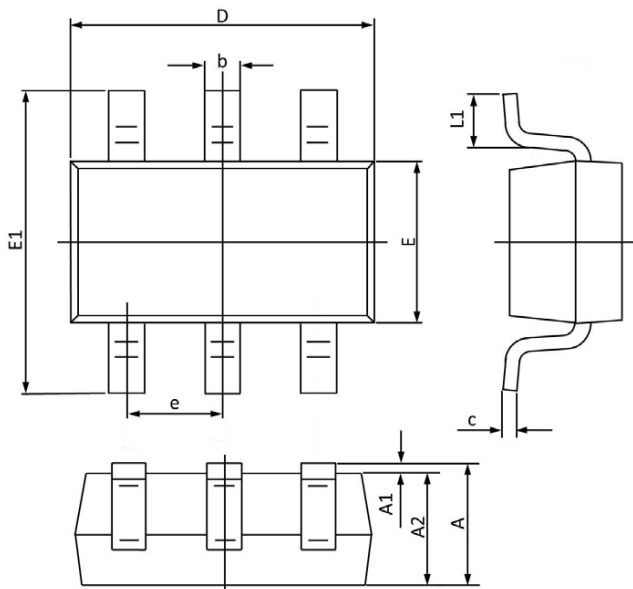


**Figure 7. Normalized Transient Impedance**



**Figure 8. Normalized  $V_{th}$  VS  $T_J$**

**Package Outline Dimensions (SOT-363)**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.100	0.800	0.043	0.031
A1	0.100	0.000	0.004	0.000
A2	1.000	0.800	0.039	0.031
b	0.330	0.100	0.013	0.004
c	0.250	0.100	0.010	0.004
D	2.200	1.800	0.087	0.071
E	1.350	1.150	0.053	0.045
E1	2.400	1.800	0.094	0.071
e	0.65BSC		0.026BSC	
L1	0.350	0.100	0.014	0.004

**Order Information**

Device	Package	Marking Code	Carrier	Quantity	HSF Status
GSFK0300B	SOT-363	U	Tape & Reel	3000/Reel	RoHS Compliant